

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	5611	((438/622) or (438/631) or (438/637) or (438/675)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/06 13:12
S15 6	3772702	airgap gap pocket aperature opening	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:16
S15 7	1769182	wire wiring damascene metalliz\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:12
S15 8	81616	(second! multiple multi) adj (insulat\$4 dielectric oxide nitride low-dielectric\$ low adj dielectric low adj k low-k hsq (hydrogen methylat\$4) adj2 silsesquioxane msq methylsilsesquioxane mhsq silk sog spin adj on adj glass fox flow\$4 adj oxide parylene cytop bcp benzocyclobutene)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:15
S15 9	1151	S156 with S157 with S158	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:15
S16 0	933	S159 and (@ad < "20030117")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:17
S16 1	84855	airgap air adj gap air-gap	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:16
S16 2	42	(S161 and S158 and S157).ab.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:22
S16 3	35	S162 and (@ad < "20030117")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:23

S16 4	68	(S161 same S158 same S157)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:23
S16 5	54	S164 and (@ad < "20030117")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:50
S16 6	24	S165 not S163	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:23
S16 7	170890	( low-dielectric\$ low adj dielectric low adj k low-k hsq (hydrogen methylat\$4) adj2 silsesquioxane msq methylsilsesquioxane mhsq silk sog spin adj on adj glass fox flow\$4 adj oxide parylene cytop bcp benzocyclobutene)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:50
S16 8	3226	fluorosilicate adj glass fsg	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:50
S16 9	38721	( low-dielectric\$ low adj dielectric low adj k low-k )	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:50
S17 0	113	S168 near S169	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:50
S17 1	76	S170 and (@ad < "20030117")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:50
S17 2	1769182	wire wiring damascene metalliz\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:53

S17 3	24082	(third multiple multi) adj (insulat\$4 dielectric oxide nitride low-dielectric\$ low adj dielectric low adj k low-k hsq (hydrogen methylat\$4) adj2 silsesquioxane msq methylsilsesquioxane mhsq silk sog spin adj on adj glass fox flow\$4 adj oxide parylene cytop bcp benzocyclobutene)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:53
S17 4	5308451	airgap gap pocket aperature opening space	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:53
S17 5	316	S172 with S173 with S174	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:53
S17 6	253	S175 and (@ad < "20030117")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 19:53